

SSM3K02T

High Speed Switching Applications

- Small package
- Low on resistance: $R_{on} = 200 \text{ m}\Omega$ (max) ($V_{GS} = 4 \text{ V}$)
 $R_{on} = 250 \text{ m}\Omega$ (max) ($V_{GS} = 2.5 \text{ V}$)
- Low gate threshold voltage: $V_{th} = 0.6 \sim 1.1 \text{ V}$ ($V_{DS} = 3 \text{ V}$, $I_D = 0.1 \text{ mA}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

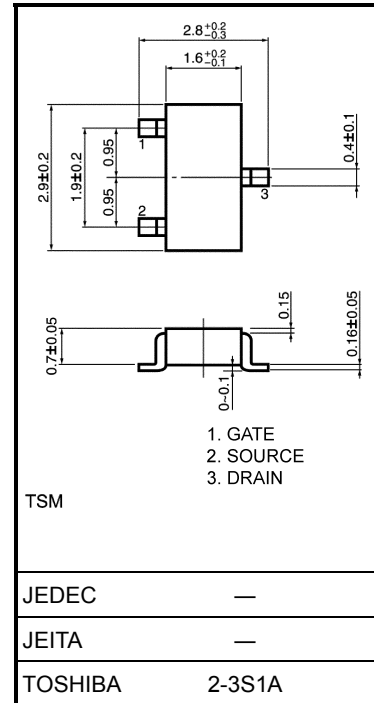
Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DS}	30	V
Gate-source voltage		V_{GSS}	± 10	V
Drain current	DC	I_D	2.5	A
	Pulse	I_{DP}	5.0	
Drain power dissipation ($T_a = 25^\circ\text{C}$)		P_D (Note1)	1250	mW
Channel temperature		T_{ch}	150	$^\circ\text{C}$
Storage temperature range		T_{stg}	$-55 \sim 150$	$^\circ\text{C}$

Note1: Mounted on FR4 board

($25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}$, Cu pad: 645 mm^2 , $t = 10 \text{ s}$)

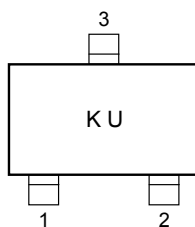
Note2: The pulse width limited by max channel temperature.

Unit: mm

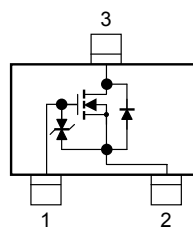


Weight: 0.01 g (typ.)

Marking



Equivalent Circuit



Handling Precaution

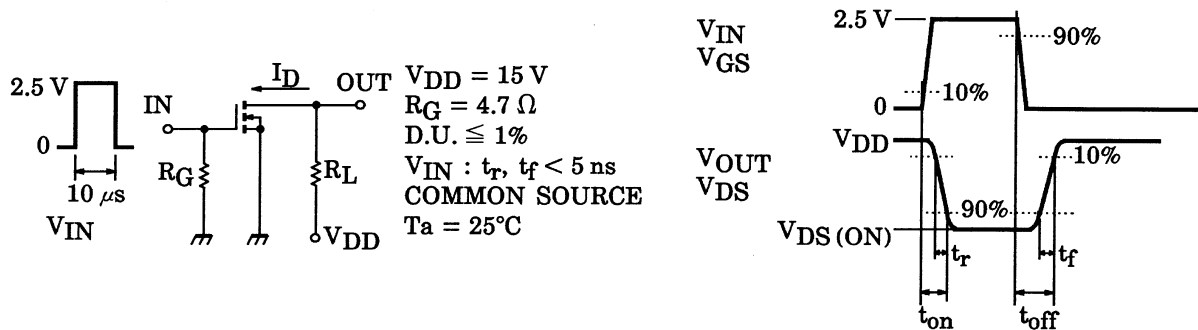
When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	—	—	± 5	μA
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1 \text{ mA}, V_{GS} = 0$	30	—	—	V
Drain cut-off current	I_{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0$	—	—	1	μA
Gate threshold voltage	V_{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6	—	1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3 \text{ V}, I_D = 1.25 \text{ A}$ (Note)	2.2	—	—	S
Drain-source ON resistance	$R_{DS(ON)}$	$I_D = 1.25 \text{ A}, V_{GS} = 4 \text{ V}$ (Note)	—	140	200	$\text{m}\Omega$
		$I_D = 1.25 \text{ A}, V_{GS} = 2.5 \text{ V}$ (Note)	—	180	250	
Input capacitance	C_{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	115	—	pF
Reverse transfer capacitance	C_{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	24	—	pF
Output capacitance	C_{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	60	—	pF
Switching time	Turn-on time	$V_{DD} = 15 \text{ V}, I_D = 0.5 \text{ A},$ $V_{GS} = 0 \sim 2.5 \text{ V}, R_G = 4.7 \Omega$	—	52	—	ns
	Turn-off time		—	80	—	

Note: Pulse test

Switching Time Test Circuit



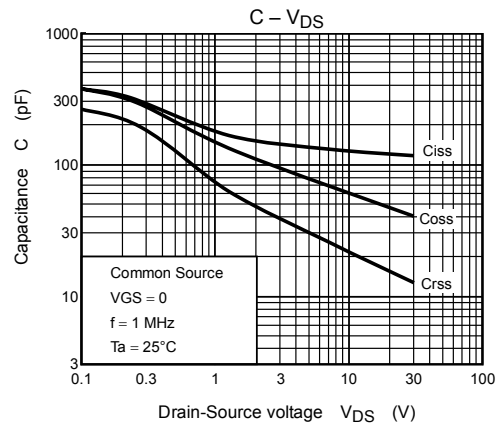
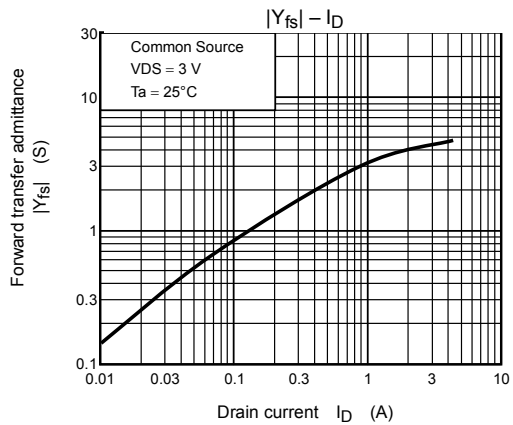
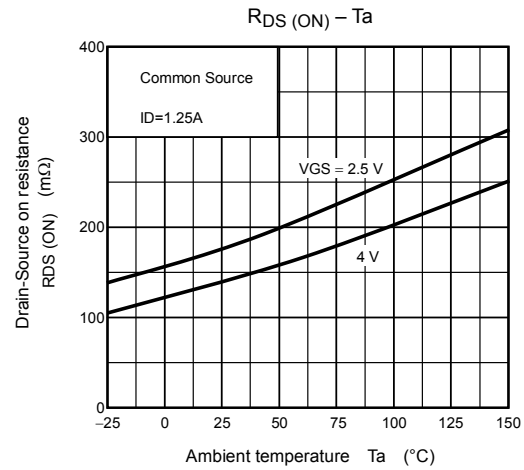
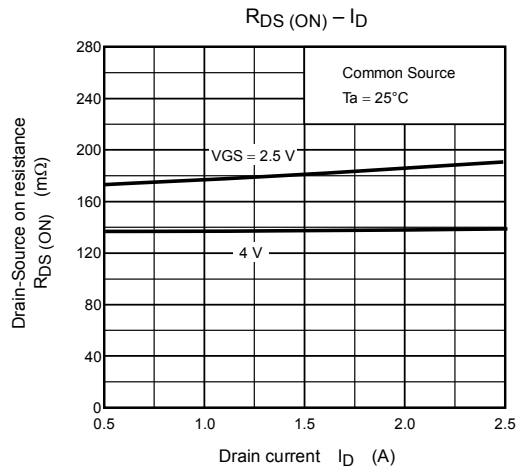
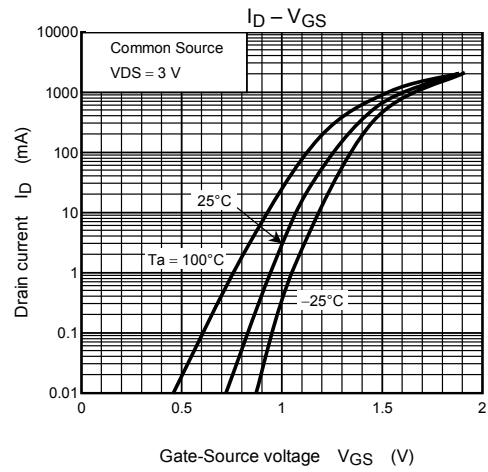
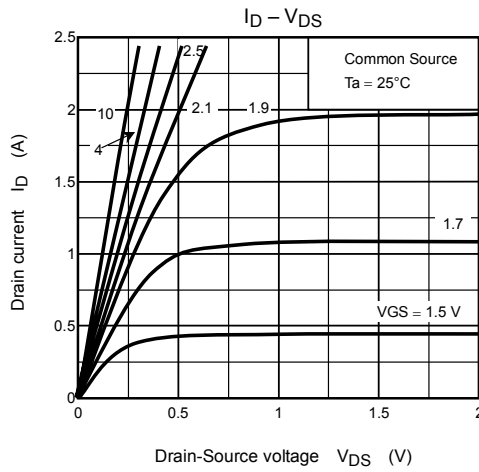
Precaution

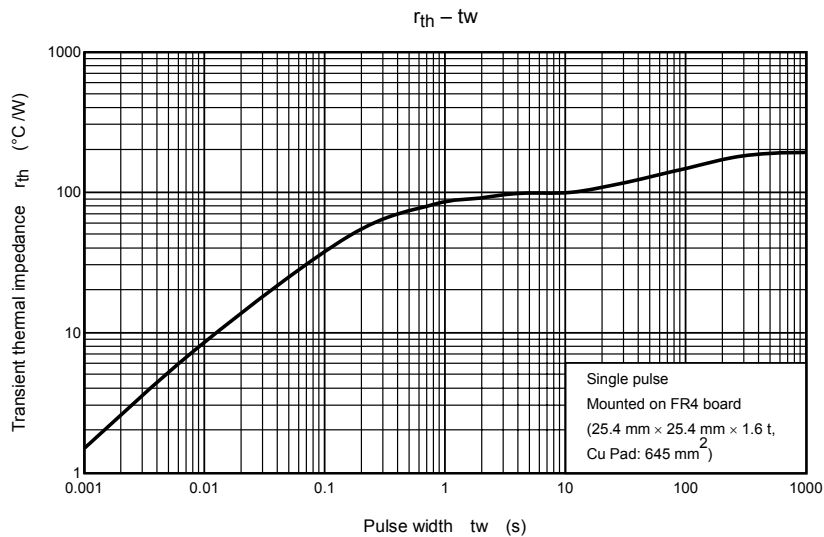
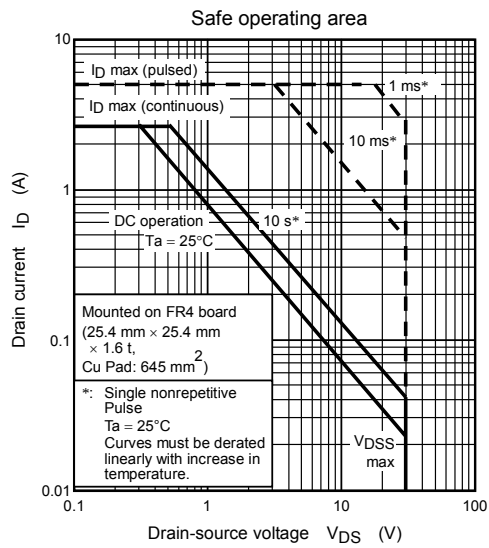
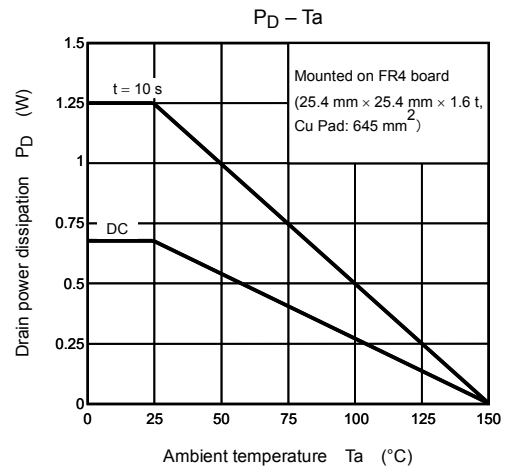
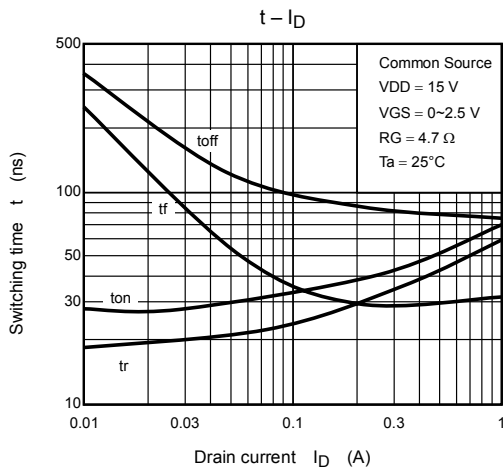
V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = 100 \mu\text{A}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires higher voltage than V_{th} and $V_{GS(off)}$ requires lower voltage than V_{th} .

(Relationship can be established as follows: $V_{GS(off)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration for using the device.

V_{GS} recommended voltage of 2.5 V or higher to turn on this product.





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